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<u>Texas Instruments</u> <u>SN74ALVTH16374KR</u>

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Datasheet of SN74ALVTH16374KR - IC D-TYPE POS TRG DUAL 56BGA

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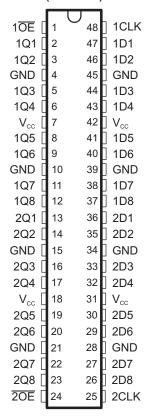
SN54ALVTH16374, SN74ALVTH16374 2.5-V/3.3-V 16-BIT EDGE-TRIGGERED D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS

SCES068G-JUNE 1996-REVISED NOVEMBER 2006

FEATURES

- State-of-the-Art Advanced BiCMOS
 Technology (ABT) Widebus™ Design for 2.5-V
 and 3.3-V Operation and Low Static Power
 Dissipation
- Support Mixed-Mode Signal Operation (5-V Input and Output Voltages With 2.3-V to 3.6-V V_{CC})
- Typical V_{OLP} (Output Ground Bounce) <0.8 V at V_{CC} = 3.3 V, T_A = 25°C
- High Drive (-24/24 mA at 2.5-V V_{CC} and -32/64 mA at 3.3-V)
- Power Off Disables Outputs, Permitting Live Insertion
- High-Impedance State During Power Up and Power Down Prevents Driver Conflict
- Uses Bus Hold on Data Inputs in Place of External Pullup/Pulldown Resistors to Prevent the Bus From Floating
- Auto3-State Eliminates Bus Current Loading When Output Exceeds V_{CC} + 0.5 V
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection
 - Exceeds 2000 V Per MIL-STD-883, Method 3015
 - Exceeds 200 V Using Machine Model
 - Exceeds 1000 V Using Charged-Device Model, Robotic Method
- Flow-Through Architecture Facilitates Printed Circuit Board Layout
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- Package Options Include Plastic Shrink Small-Outline (DL), Thin Shrink Small-Outline (DGG), Thin Very Small-Outline (DGV) Packages, and 380-mil Fine-Pitch Ceramic Flat (WD) Package

SN54ALVTH16374...WD PACKAGE SN74ALVTH16374...DGG, DGV, OR DL PACKAGE (TOP VIEW)



DESCRIPTION/ORDERING INFORMATION

The 'ALVTH16374 devices are 16-bit edge-triggered D-type flip-flops with 3-state outputs designed for 2.5-V or 3.3-V V_{CC} operation, but with the capability to provide a TTL interface to a 5-V system environment. These devices are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

These devices can be used as two 8-bit flip-flops or one 16-bit flip-flop. On the positive transition of the clock (CLK), the flip-flops store the logic levels set up at the data (D) inputs.



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DESCRIPTION/ORDERING INFORMATION (CONTINUED)

A buffered output-enable (\overline{OE}) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and the increased drive provide the capability to drive bus lines without need for interface or pullup components.

OE does not affect internal operations of the flip-flop. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

When V_{CC} is between 0 and 1.2 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 1.2 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ALVTH16374 is characterized for operation over the full military temperature range of -55°C to 125°C.

The SN74ALVTH16374 is characterized for operation from -40°C to 85°C.

ORDERING INFORMATION

T _A	P/	ACKAGE	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	TSSOP – DGG	Reel of 2000	74ALVTH16374GRE4	
	1330F - DGG	Reel of 2000	SN74ALVTH16374GR	
	TVCOD DCV	Dool of 2000	74ALVTH16374VRE4	
40°C to 05°C	TVSOP – DGV	Reel of 2000	SN74ALVTH16374VR	
–40°C to 85°C		Tube of 25	74ALVTH16374DL	
	CCOD DI	Tube of 25	SN74ALVTH16374DLG4	
	SSOP – DL	D = =1 = £ 4.000	SN74ALVTH16374DLR	
		Reel of 1000	SN74ALVTH16374DLRG4	



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ZQL PACKAGE (TOP VIEW)

1 2 3 4 5 6 000000 000000 В 000000 С 000000 D \bigcirc \bigcirc Ε F \bigcirc \bigcirc 000000 G 000000 Н 000000 J 000000 Κ

TERMINAL ASSIGNMENTS(1)

	1	2	3	4	5	6
Α	1 OE	NC	NC	NC	NC	1CLK
В	1Q2	1Q1	GND	GND	1D1	1D2
С	1Q4	1Q3	V _{cc}	V _{cc}	1D3	1D4
D	1Q6	1Q5	GND	GND	1D5	1D6
E	1Q8	1Q7			1D7	1D8
F	2Q1	2Q2			2D2	2D1
G	2Q3	2Q4	GND	GND	2D4	2D3
Н	2Q5	2Q6	V _{CC}	V _{CC}	2D6	2D5
J	2Q7	2Q8	GND	GND	2D8	2D7
K	2 OE	NC	NC	NC	NC	2CLK

⁽¹⁾ NC - No internal connection

FUNCTION TABLE (each 8-bit section)

	INPUTS		OUTPUT
ΟE	CLK	D	Q
L	1	Н	Н
L	\uparrow	L	L
L	H or L	Χ	Q_0
Н	Χ	X	Z

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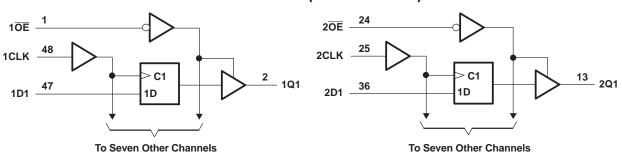
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WITH 3-STATE OUTPUTS

LOGIC DIAGRAM (POSITIVE LOGIC)



Pin numbers shown are for the DGG, DL, and WD packages.

Absolute Maximum Ratings(1)

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V_{CC}	Supply voltage range		-0.5	4.6	V
V_{I}	Input voltage range ⁽²⁾		-0.5	7	V
Vo	Voltage range applied to any output in the high-imped	dance or power-off state ⁽²⁾	-0.5	7	V
Vo	Voltage range applied to any output in the high state	(2)	-0.5	7	V
	Outside suggest in the law state	SN54ALVTH16374 ⁽³⁾		96	Λ
IO	Output current in the low state	SN74ALVTH16374		128	mA
		SN54ALVTH16374 ⁽³⁾		-48	
IO	Output current in the high state	SN74ALVTH16374		-64	mA
I _{IK}	Input clamp current	V _I < 0		-50	mA
I _{OK}	Output clamp current	V _O < 0		-50	mA
		DGG package		89	
θ_{JA}	Package thermal impedance ⁽⁴⁾	DGV package		93	°C/W
		DL package		94	
T _{stg}	Storage temperature range		-65	150	°C

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

⁽²⁾ The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

⁽³⁾ Product preview

⁽⁴⁾ The package thermal impedance is calculated in accordance with JESD 51.



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Recommended Operating Conditions⁽¹⁾

 V_{CC} = 2.5 V \pm 0.2 V

			SN54A	LVTH16	374 ⁽²⁾	SN74AL	VTH163	374	UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	UNII
V _{CC}	Supply voltage		2.3		2.7	2.3		2.7	V
V _{IH}	High-level input voltage		1.7			1.7			V
V _{IL}	Low-level input voltage				0.7			0.7	V
VI	Input voltage		0	V_{CC}	5.5	0	V_{CC}	5.5	V
I _{OH}	High-level output current				-6			-8	mA
	Low-level output current				6			8	mA
I _{OL}	Low-level output current; current duty cycle	≤ 50%; f ≥ 1 kHz			18			24	IIIA
Δt/Δν	Input transition rise or fall rate	Outputs enabled			10			10	ns/V
$\Delta t/\Delta V_{CC}$	Power-up ramp rate		200			200			μs/V
T _A	Operating free-air temperature		-55		125	-40		85	Ô

All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

Recommended Operating Conditions(1)

 $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$

			SN54AI	_VTH163	374 ⁽²⁾	SN74A	LVTH16	374	UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	UNIT
V_{CC}	Supply voltage		3		3.6	3		3.6	V
V_{IH}	High-level input voltage		2			2			V
V_{IL}	Low-level input voltage				0.8			8.0	V
VI	Input voltage		0	V_{CC}	5.5	0	V_{CC}	5.5	V
I _{OH}	High-level output current				-24			-32	mA
	Low-level output current				24			32	mΛ
I _{OL}	Low-level output current; current duty cy	cle ≤ 50%; f ≥ 1 kHz			48			64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled			10			10	ns/V
$\Delta t/\Delta V_{CC}$	Power-up ramp rate		200			200			μs/V
T _A	Operating free-air temperature		- 55		125	-40		85	°C

⁽¹⁾ All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

⁽²⁾ Product preview

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Electrical Characteristics

over operating free-air temperature range V_{CC} = 2.5 V \pm 0.2 V (unless otherwise noted)

	DADAMETED	TEST OF	NOTIONS	SN54ALVT	H1637	4 (1)	SN74ALV	/TH1637	4	LINUT
	PARAMETER	IESI CO	ONDITIONS	MIN T	YP ⁽²⁾	MAX	MIN	TYP ⁽²⁾	MAX	UNIT
V_{IK}		$V_{CC} = 2.3 \text{ V},$	$I_1 = -18 \text{ mA}$			-1.2			-1.2	V
		$V_{CC} = 2.3 \text{ V to } 2.7$	$V, I_{OH} = -100 \mu A$	V _{CC} - 0.2			V _{CC} - 0.2			
V_{OH}		V 0.0 V	$I_{OH} = -6 \text{ mA}$	1.8						V
		V _{CC} = 2.3 V	$I_{OH} = -8 \text{ mA}$				1.8	,		
		$V_{CC} = 2.3 \text{ V to } 2.7$	V, I _{OL} = 100 μA			0.2			0.2	
			I _{OL} = 6 mA			0.4		,		
V_{OL}		V 22V	I _{OL} = 8 mA						0.4	V
		$V_{CC} = 2.3 \text{ V}$	I _{OL} = 18 mA			0.5				
			I _{OL} = 24 mA						0.5	
	Control innuts	$V_{CC} = 2.7 \text{ V},$	$V_I = V_{CC}$ or GND			±1		,	±1	
	Control inputs	$V_{CC} = 0 \text{ or } 2.7 \text{ V},$	V _I = 5.5 V			10			10	
I_{\parallel}			V _I = 5.5 V			10			10	μΑ
	Data inputs	$V_{CC} = 2.7 \text{ V}$	$V_I = V_{CC}$			1			1	
			V _I = 0			-5		,	-5	
I _{off}		$V_{CC} = 0,$ $V_{I} \text{ or } V_{O} = 0 \text{ to } 4.5$	i V						±100	μΑ
I _{BHL} (3)	$V_{CC} = 2.3 \text{ V},$	V _I = 0.7 V		115			115		μΑ
I _{BHH}	(4)	$V_{CC} = 2.3 \text{ V},$	V _I = 1.7 V		-10			-10		μΑ
I _{BHLC}) ⁽⁵⁾	V _{CC} = 2.7 V,	$V_I = 0$ to V_{CC}	300			300			μΑ
I _{BHH}	O ⁽⁶⁾	$V_{CC} = 2.7 \text{ V},$	$V_I = 0$ to V_{CC}	-300			-300	,		μΑ
I _{EX} ⁽⁷)	$V_{CC} = 2.3 \text{ V},$	V _O = 5.5 V			125		,	125	μΑ
I _{OZ(P}	U/PD) ⁽⁸⁾	$V_{CC} \le 1.2 \text{ V}, V_O = V_I = \text{GND or } V_{CC},$	0.5 V to V _{CC} , OE = don't care			±100			±100	μΑ
I _{OZH}		$V_{CC} = 2.7 \text{ V}, V_{O} = V_{I} = 0.7 \text{ V} \text{ or } 1.7 \text{ V}$	2.3 V,			5			5	μΑ
I _{OZL}		$V_{CC} = 2.7 \text{ V}, V_{O} = V_{I} = 0.7 \text{ V} \text{ or } 1.7 \text{ V}$				-5			-5	μΑ
		V _{CC} = 2.7 V,	Outputs high		0.04	0.1			0.1	
I_{CC}		$I_0 = 0$	Outputs low		2.3	4.5			4.5	mA
		$V_I = V_{CC}$ or GND	Outputs disabled		0.04	0.1			0.1	
Ci		V _{CC} = 2.5 V,	V _I = 2.5 V or 0		3.5					pF
C _o		$V_{CC} = 2.5 \text{ V},$	V _O = 2.5 V or 0		6					pF

- (1) Product preview
- All typical values are at $V_{CC} = 2.5 \text{ V}$, $T_A = 25^{\circ}\text{C}$. (2)
- (3) The bus-hold circuit can sink at least the minimum low sustaining current at V_{IL} max. I_{BHL} should be measured after lowering V_{IN} to GND and then raising it to V_{IL} max.
- (4) The bus-hold circuit can source at least the minimum high sustaining current at V_{IH} min. I_{BHH} should be measured after raising V_{IN} to V_{CC} and then lowering it to V_{IH} min.
- An external driver must source at least I_{BHLO} to switch this node from low to high.
- An external driver must sink at least I_{BHHO} to switch this node from high to low. Current into an output in the high state when $V_O > V_{CC}$ (6)
- (8) High-impedance state during power up or power down



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Electrical Characteristics

over recommended operating free-air temperature range $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ (unless otherwise noted)

	DADAMETED	TEST COM	DITIONS	SN54AL\	/TH1637	4 (1)	SN74	ALVTH16	374	LINUT
	PARAMETER	TEST CON	DITIONS	MIN	TYP ⁽²⁾	MAX	MIN	TYP ⁽²⁾	MAX	UNIT
V_{IK}		V _{CC} = 3 V,	$I_1 = -18 \text{ mA}$			-1.2			-1.2	V
		$V_{CC} = 3 \text{ V to } 3.6 \text{ V},$	$I_{OH} = -100 \mu A$	V _{CC} - 0.2			V _{CC} - 0.2			
V _{OH}		V 2.V	$I_{OH} = -24 \text{ mA}$	2						V
		$V_{CC} = 3 V$	$I_{OH} = -32 \text{ mA}$				2			
		$V_{CC} = 3 \text{ V to } 3.6 \text{ V},$	I _{OL} = 100 μA			0.2			0.2	
			I _{OL} = 16 mA						0.4	
\/			I _{OL} = 24 mA			0.5				V
V _{OL}		$V_{CC} = 3 V$	I _{OL} = 32 mA						0.5	V
			I _{OL} = 48 mA			0.55				
			I _{OL} = 64 mA						0.55	
	Control innute	$V_{CC} = 3.6 \text{ V}, V_{I} = V_{CC}$	or GND			±1			±1	
	Control inputs	$V_{CC} = 0 \text{ or } 3.6 \text{ V}, V_{I} =$	5.5 V			10			10	
I			V _I = 5.5 V			10			10	μΑ
	Data inputs	V _{CC} = 3.6 V	$V_I = V_{CC}$			1			1	
			V _I = 0			-5			-5	
I _{off}		$V_{CC} = 0$, V_I or $V_O = 0$	to 4.5 V						±100	μΑ
I _{BHL}	(3)	V _{CC} = 3 V,	V _I = 0.8 V	75			75			μΑ
I _{BHH}	(4)	V _{CC} = 3 V,	V _I = 2 V	-75			-75			μΑ
I _{BHL}	o ⁽⁵⁾	V _{CC} = 3.6 V,	$V_I = 0$ to V_{CC}	500			500			μΑ
I _{BHH}	O ⁽⁶⁾	V _{CC} = 3.6 V,		-500			-500			μΑ
I _{EX} (7	7)	V _{CC} = 3 V,	V _O = 5.5 V			125			125	μΑ
I _{OZ(F}	PU/PD) ⁽⁸⁾	$V_{CC} \le 1.2 \text{ V}, V_{O} = 0.5 \text{ V}_{I} = \text{GND or } V_{CC}, \overline{\text{OE}}$	V to V _{CC} , = don't care			±100			±100	μΑ
I _{OZH}		$V_{CC} = 3.6 \text{ V}, V_{O} = 3 \text{ V}$ $V_{I} = 0.8 \text{ V or } 27 \text{ V}$	′,			5			5	μΑ
I _{OZL}		$V_{CC} = 3.6 \text{ V}, V_{O} = 0.5 \text{ V}_{I} = 0.8 \text{ V or 2 V}$	V,			- 5			-5	μΑ
		$V_{CC} = 3.6 \text{ V},$	Outputs high		0.07	0.1		0.07	0.1	
I_{CC}		$I_0 = 0$	Outputs low		3.2	5		3.2	5	mA
		$V_I = V_{CC}$ or GND	Outputs disabled		0.07	0.1			0.1	
Δl _{CC}	(9)	V_{CC} = 3 V to 3.6 V, One input at V_{CC} – 0.6 Other inputs at V_{CC} o	S V, r GND			0.4			0.4	mA
Ci		$V_{CC} = 3.3 \text{ V},$	$V_{I} = 3.3 \text{ V or } 0$		3.5			3.5		pF
Co		V _{CC} = 3.3 V,	$V_0 = 3.3 \text{ V or } 0$		6			6		pF

- Product preview
- All typical values are at V_{CC} = 2.5 V, T_A = 25°C. The bus-hold circuit can sink at least the minimum low sustaining current at V_{IL} max. I_{BHL} should be measured after lowering V_{IN} to GND and then raising it to V_{II} max.
- The bus-hold circuit can source at least the minimum high sustaining current at V_{IH} min. I_{BHH} should be measured after raising V_{IN} to (4) $V_{\mbox{\footnotesize CC}}$ and then lowering it to $V_{\mbox{\footnotesize IH}}$ min.
- An external driver must source at least I_{BHLO} to switch this node from low to high.
- An external driver must sink at least $I_{\mbox{\footnotesize{BHHO}}}$ to switch this node from high to low. (6)
- Current into an output in the high state when $V_O > V_{CC}$
- High-impedance state during power up or power down
- This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.



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Timing Requirements

over recommended operating free-air temperature range V_{CC} = 2.5 V \pm 0.2 V (unless otherwise noted) (see Figure 1)

			SN54ALVTH	16374 ⁽¹⁾	SN74ALVTH	16374	UNIT
			MIN	MAX	MIN	MAX	UNIT
f _{clock}	Clock frequency			150		150	MHz
t _w	Pulse duration, CLK high or low		1.5		1.5		ns
	Setup time, data before CLK↑	Data high	1.1		1		20
t _{su}	Setup time, data before CLK	Data low	1.4		1.3		ns
	Hold time, data after CLK↑	Data high	0.6		0.5		20
t _h	Hold time, data after CLK	Data low	0.9		0.8		ns

⁽¹⁾ Product preview

Timing Requirements

over recommended operating free-air temperature range V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 2)

			SN54ALVTH	16374 ⁽¹⁾	SN74ALVTI	116374	LINUT
			MIN	MAX	MIN	MAX	UNIT
f _{clock}	Clock frequency			25		250	MHz
t _w	Pulse duration, CLK high or low		1.5		1.5		ns
	Saturations data before CLIV	Data high	1.1		1		
l _{su}	Setup time, data before CLK↑	Data low	1.6		1.5		ns
	Hald time and the CLIVA	Data high	0.6		0.5		
t _h	Hold time, data after CLK↑	Data low	1.1		1		ns

⁽¹⁾ Product preview



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Switching Characteristics

over recommended operating free-air temperature range, C_L = 30 pF, V_{CC} = 2.5 V \pm 0.2 V (unless otherwise noted) (see Figure 1)

DADAMETED	FROM	то	SN54ALVTH10	6374 ⁽¹⁾	SN74ALVTH	116374	LINUT
PARAMETER	(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	UNIT
f _{max}			150		150		MHz
t _{PLH}	CLK	0	1.4	3.9	1.5	3.8	
t _{PHL}	CLK	Q	1.4	3.9	1.5	3.8	ns
t _{PZH}	- OE	0	1	4.2	1	4.1	no
t _{PZL}	OE OE	Q	1	3.8	1	3.7	ns
t _{PHZ}	- OE	0	1.7	4.3	1.8	4.2	
t _{PLZ}	OE OE	Q	1	3.5	1	3.4	ns

⁽¹⁾ Product preview

Switching Characteristics

over recommended operating free-air temperature range, C_L = 50 pF, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 2)

DADAMETED	FROM	то	SN54ALVTH1	6374 ⁽¹⁾	SN74ALVTH	16374	LIMIT
PARAMETER	(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	UNIT
f _{max}			250		250		MHz
t _{PLH}	CLK	Q	1	3.4	1	3.2	20
t _{PHL}	CLK	Q	1	3.3	1	3.2	ns
t _{PZH}	ŌĒ	Q	1	3.9	1	3.8	20
t _{PZL}	OE	Q	1	3.4	1	3.3	ns
t _{PHZ}	ŌĒ	0	1	4.7	1	4.6	20
t _{PLZ}	OE	Q	1	4.4	1	4.2	ns

(1) Product preview

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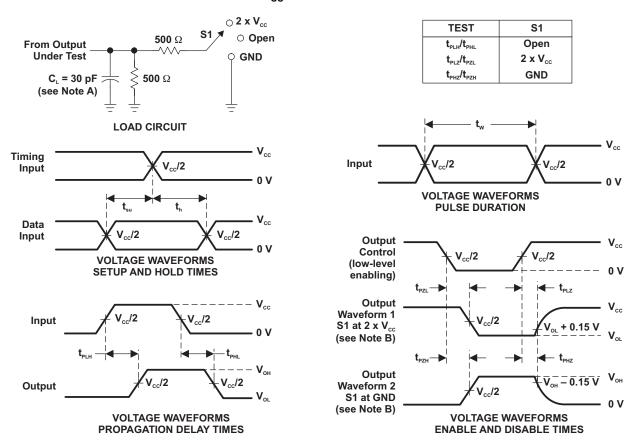
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SN54ALVTH16374, SN74ALVTH16374 2.5-V/3.3-V 16-BIT EDGE-TRIGGERED D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS



SCES068G-JUNE 1996-REVISED NOVEMBER 2006

PARAMETER MEASUREMENT INFORMATION $V_{cc} = 2.5 V \pm 0.2 V$



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_o = 50 Ω , $t_i \leq$ 2 ns,
- D. The outputs are measured one at a time, with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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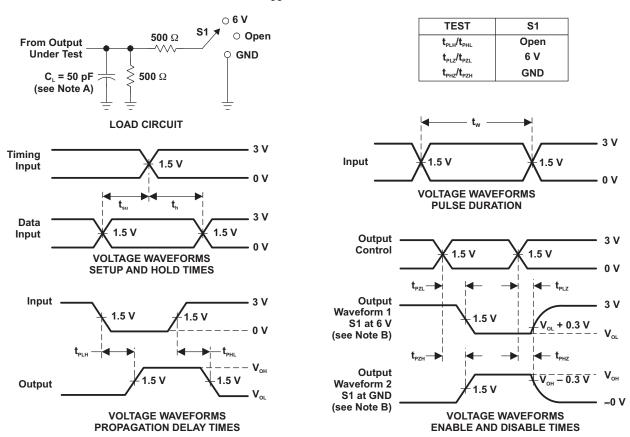
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SN54ALVTH16374, SN74ALVTH16374 2.5-V/3.3-V 16-BIT EDGE-TRIGGERED D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS

SCES068G-JUNE 1996-REVISED NOVEMBER 2006

PARAMETER MEASUREMENT INFORMATION V_{cc} = 3.3 V ± 0.3 V



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_o = 50 \Omega$, $t_i \leq 2.5 \text{ ns}$, $t_i \leq 2.5 \text{ ns}$
- D. The outputs are measured one at a time, with one transition per measurement.

Figure 2. Load Circuit and Voltage Waveforms



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PACKAGE OPTION ADDENDUM

10-Jun-2014

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing		Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
74ALVTH16374ZQLR	ACTIVE	BGA MICROSTAR JUNIOR	ZQL	56	1000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 85	VT374	Samples
SN74ALVTH16374DL	ACTIVE	SSOP	DL	48	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	ALVTH16374	Samples
SN74ALVTH16374DLR	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	ALVTH16374	Samples
SN74ALVTH16374GR	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	ALVTH16374	Samples
SN74ALVTH16374KR	OBSOLETI	BGA MICROSTAR JUNIOR	GQL	56		TBD	Call TI	Call TI	-40 to 85		
SN74ALVTH16374VR	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	VT374	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available. **OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

Information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free/Green conversio

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device

Addendum-Page 1



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PACKAGE OPTION ADDENDUM

www.ti.com 10-Jun-2014

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "--" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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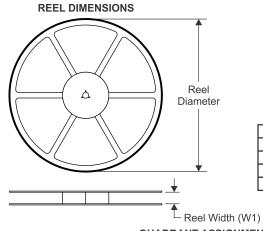
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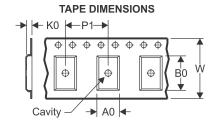


PACKAGE MATERIALS INFORMATION

www.ti.com 9-Jan-2013

TAPE AND REEL INFORMATION





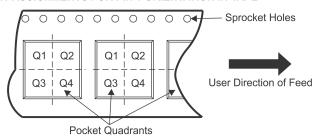
A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
140	Discouries desired to a second state the

K0 Dimension designed to accommodate the component thickness

W Overall width of the carrier tape

P1 Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

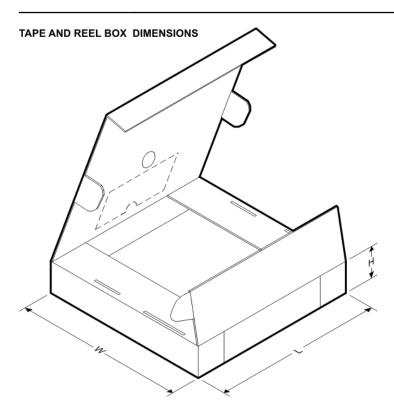
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
74ALVTH16374ZQLR	BGA MI CROSTA R JUNI OR	ZQL	56	1000	330.0	16.4	4.8	7.3	1.5	8.0	16.0	Q1
SN74ALVTH16374DLR	SSOP	DL	48	1000	330.0	32.4	11.35	16.2	3.1	16.0	32.0	Q1
SN74ALVTH16374GR	TSSOP	DGG	48	2000	330.0	24.4	8.6	15.8	1.8	12.0	24.0	Q1
SN74ALVTH16374VR	TVSOP	DGV	48	2000	330.0	16.4	7.1	10.2	1.6	12.0	16.0	Q1

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*All dimensions are nominal

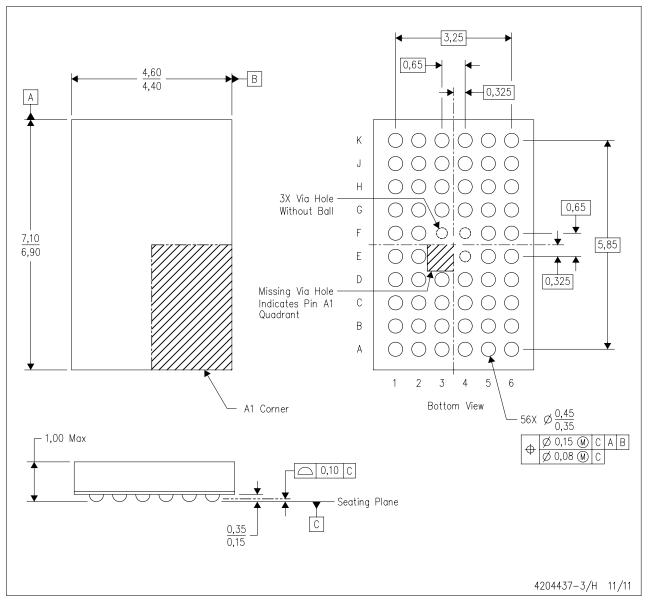
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
74ALVTH16374ZQLR	BGA MICROSTAR JUNIOR	ZQL	56	1000	333.2	345.9	28.6
SN74ALVTH16374DLR	SSOP	DL	48	1000	367.0	367.0	55.0
SN74ALVTH16374GR	TSSOP	DGG	48	2000	367.0	367.0	45.0
SN74ALVTH16374VR	TVSOP	DGV	48	2000	367.0	367.0	38.0



MECHANICAL DATA

ZQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MO-285 variation BA-2.
- D. This package is Pb-free. Refer to the 56 GQL package (drawing 4200583) for tin-lead (SnPb).

MicroStar Junior is a trademark of Texas Instruments





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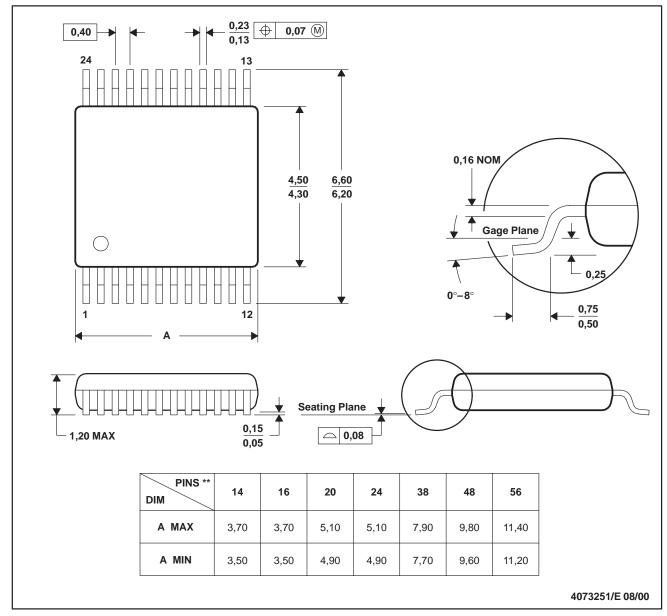
MECHANICAL DATA

MPDS006C - FEBRUARY 1996 - REVISED AUGUST 2000

DGV (R-PDSO-G**)

24 PINS SHOWN

PLASTIC SMALL-OUTLINE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153

14/16/20/56 Pins - MO-194

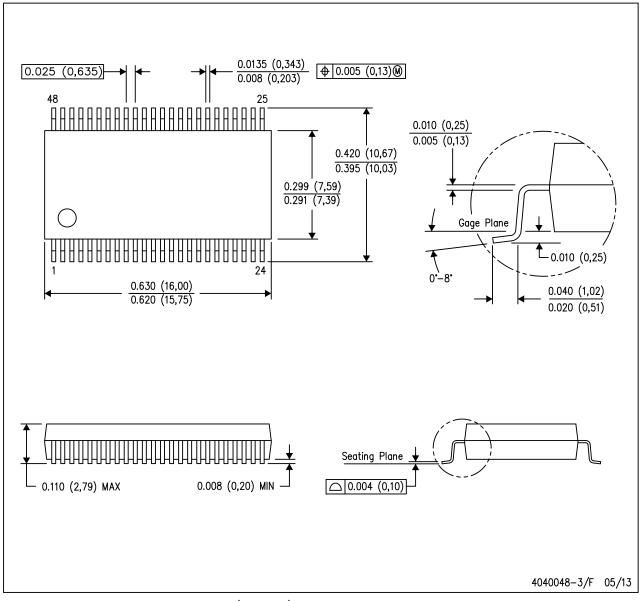




MECHANICAL DATA

DL (R-PDSO-G48)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

PowerPAD is a trademark of Texas Instruments.

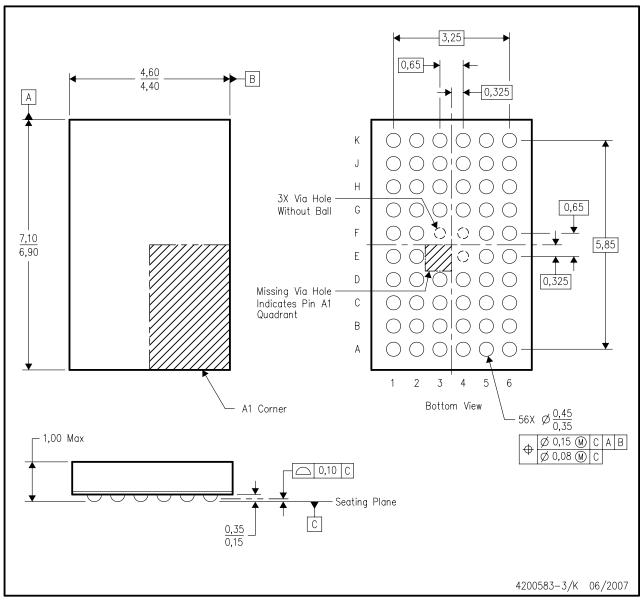




MECHANICAL DATA

GQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MO-285 variation BA-2.
- D. This package is tin-lead (SnPb). Refer to the 56 ZQL package (drawing 4204437) for lead-free.





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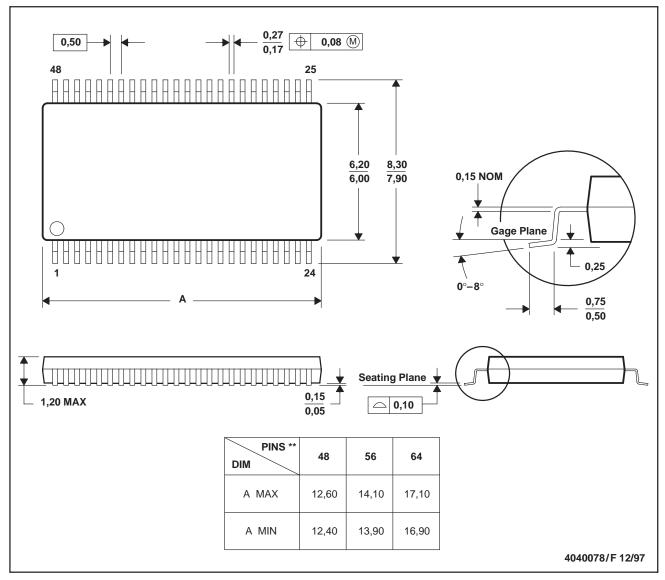
MECHANICAL DATA

MTSS003D - JANUARY 1995 - REVISED JANUARY 1998

DGG (R-PDSO-G**)

48 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153





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